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Co-Fe-B/MgO/Ge Spin Photodiode Operating at Telecommunication Wavelength with Zero Applied Magnetic Field

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We report on the growth and study of Co-Fe-B/MgO/Ge(001) spin photodiode by using a combination of both molecular beam epitaxy (MBE) and sputtering methods. An epitaxial growth of MgO on Ge in MBE is achieved by the deposition of MgO at room temperature (RT) followed by a post-growth annealing at 300 °C. The spin detector, which consists of 1.1-nm ultrathin Co-Fe-B layer capped with 5-nm Ta is subsequently grown by sputtering at RT. After a post-growth annealing of the whole structure at 250 °C, we obtain clear evidence of a strong perpendicular magnetic anisotropy in the temperature range 10-300 K. Co-Fe-B/MgO/Ge(001) heterojunctions are then processed into spin photodiodes demonstrating at zero magnetic field a photocurrent helicity asymmetry of about 0.9% at 9 K and 0.1% at RT at the telecommunication wavelength of 1310 nm. The demonstration of a spin photodiode working at a telecommunication wavelength with zero applied magnetic field is of great interest for future applications of the optical transport of spin information.

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I. INTRODUCTION

The evolution of microelectronics is guided by Moore’s law, which will soon be confronted with fundamental physical limits, thus hampering future developments. For this reason, alternative device concepts exploring new functionalities have been envisioned. Among these, devices that exploit the spin as a new degree of freedom instead of, or in addition to the electron charge, could lead to great benefits. This has led to the birth of a new and very rapidly growing research field called spin-electronics [1]. When spintronics is associated with semiconductors, hybrid devices which integrate both ferromagnetic materials and semiconductor materials onto the same chip can be envisioned. This will be of particular interest since all operations such as storing and processing of information could then be integrated within one technology [2]. Remarkable successes have been achieved in this field during the last decade with different semiconductor materials [3–6]. One of the important achievements is the spin injection from a ferromagnetic contact into a semiconductor overcoming the resistance mismatch by inserting a thin oxide tunnel barrier at the metal/semiconductor interface [7]. Moreover, the development of spin-polarized light-emitting diodes (spin-LEDs) in which spin-polarized electrons are electrically injected into the active region of a semiconductor where they recombine radiatively with unpolarized holes to emit right- or left-circularly polarized light is of prime importance. It was found that the ferromagnetic spin injector plays a key role in determining the efficiency of the spin injection [8,9]. In most cases, the spin-LED was studied in III-V-based semiconductors such as GaAs [10–14] or GaN [15–17]. However, the reverse process: a spin photodiode [18], i.e., the electrical detection of a spin-polarized current when a ferromagnetic/insulator/semiconductor heterojunction is illuminated by a circularly polarized light has gained much less attention. Hirohata et al. [19] investigated the spin-dependent electron transport at the interface between NiFe and n-doped GaAs(110). They reported a 1% relative variation of the photocurrent at room temperature (RT). Taniyama et al. [20] studied spin transport across Fe/GaAs(001) and Fe/AlOx/GaAs(001) heterojunctions. The photocurrent variation was found to be strongly dependent on the applied magnetic field and reaches a maximum of 1.7% at RT. Hövel et al. [21] realized a photodetector using a p-i-n diode with a GaAs quantum well in the active region and a Fe/Tb multilayer on top of a MgO heterojunction.
layer to ensure filtering of the spin-polarized current at zero external magnetic field. The authors obtained a relatively large photocurrent helicity asymmetry of 3% at RT and in remanence. More recently, in order to avoid the use of an external magnetic field, Roca et al. [22] and Zhu et al. [23] have reported the possibility to operate under an oblique incident angle using in-plane magnetic injectors on top of the semiconductor part of the device.

While most previous studies of spin photodiodes have mainly focused on the GaAs-based semiconductor material, more recently, germanium (Ge) has also emerged as a promising material for spintronics due to its rather large spin-orbit coupling [24] and long electron-spin lifetimes [25]. Electrical spin injection, transport, and detection has been studied experimentally in bulk Ge [5,26]. Very recently, fully epitaxial Fe/MgO/Ge(001) spin photodiodes were experimentally demonstrated showing a net photocurrent variation of about 5% when being excited at 0.95 eV (i.e., 1300 nm) with a 100% circularly right- and left-polarized light [27,28]. The key advantage here, compared to previous GaAs-based spin photodiodes proof-of-concepts, lies in the wavelength range corresponding to the telecommunication wavelength. In order to fulfill the optical selection rules [29], the magnetization needs to be out-of-plane. For this purpose, Rinaldi et al. [28] applied an external magnetic field of up to 1.2 Tesla to drive the magnetization of the 10-nm-thick Fe layer to the out-of-plane configuration. However, this appears to be a strong limitation for future practical device applications. Moreover, the Zeeman effect due to a large magnetic field could also complicate the data analysis [30]. Therefore, a layered structure exhibiting a perpendicular magnetic anisotropy (PMA) would be highly desirable. Furthermore, in order to get a sensitive photodetector and to minimize spurious effects such as the magnetic circular dichroism (MCD) effect, one should also minimize the light absorption in the top magnetic layer of the photodiode. To this aim, a magnetic spin detector with a thickness close to one nanometer would be of great interest. The demonstration of the growth of such an ultrathin magnetic spin detector presenting a PMA on Ge for a zero applied magnetic field spin photodiode is, however, still lacking.

In this paper, we investigate the growth and spin-polarized photocurrent properties of an ultrathin Co-Fe-B/MgO spin detector on Ge(001) substrates. We demonstrate that a careful tuning of the growth parameters and post-growth annealing conditions allows us to obtain a spin detector with strong perpendicular magnetic anisotropy in the range 10–300 K. Finally, encouraging results concerning Co-Fe-B/MgO/Ge(001) spin photodiodes operating at zero magnetic field are obtained: a photocurrent helicity asymmetry of about 0.9% is measured at 9 K and is still detectable (about 0.1%) at RT at the telecommunication wavelength of 1310 nm. The demonstration of a spin photodiode working at a telecommunication wavelength and with a zero applied magnetic field is of great interest for future applications on the optical transport of spin information [31].

II. EXPERIMENTAL DETAILS

Nominally undoped Ge(001) substrates (resistivity >50 Ω cm) are used in this study. The ex-situ cleaning of the Ge(001) substrates is checked by atomic force microscopy (AFM) prior to their transfer into the molecular beam epitaxy (MBE) chamber. After in situ deoxidation, 2 nm of MgO are deposited at RT and subsequently annealed at 300 °C for 1 h. The growth is characterized in situ by reflection high-energy electron diffraction (RHEED). The sample is then transferred without vacuum breaking into the sputtering chamber where 0.5 nm MgO is deposited prior to the growth of a 1.1-nm-thick Co90Fe40B20 layer at RT. The heterostructure is finally capped by a 5-nm-thick Ta layer. Ex situ annealing is performed using a rapid thermal annealing (RTA) oven under an argon atmosphere at 250 °C for 3 min [14]. The magnetic properties are measured by superconducting quantum interference device (SQUID) magnetometry as a function of temperature in the range 10–300 K.

High resolution scanning transmission electron microscopy (HR-STEM) is performed to characterize the interfacial structure using a probe-corrected JEOL ARM 200 CF operated at 200 kV. High-angle annular dark-field (HAADF) and bright-field (BF) images are simultaneously recorded. Electron energy loss spectroscopy (EELS) maps are recorded with a Gatan Quantum Imaging filter. In order to be able to correct energy drift and estimate the local thickness, the zero loss and the core loss spectra are simultaneously recorded for a dispersion of 1 eV (Dual EELS method). The pixel size of spectrum images (SI) is typically fixed between 0.1 and 0.15 nm. After energy drift correction, the SI are denoised using a principal component analysis method before quantitative analysis. The SI denoising is performed with the multi-statistical analysis plugins for Digital Micrograph “temDM” [32].

Spin photodiodes based on Co-Fe-B/MgO/Ge(001) heterojunctions are processed using standard UV photolithography and Ar⁺ ion milling. First, circular mesas with a diameter of 400 μm are defined [inset of Fig. 4(a)]. Then, a second lithography step is used to define both ring-shaped top contacts and the bottom contacts. 150-nm Au/10-nm Ti are deposited as contact materials. Photocurrent measurements are performed at normal incidence under an optical excitation provided by laser diodes (wavelength 980 nm or 1310 nm). The beam is focused onto the sample with a f =20-mm lens (spot diameter of 2.5 μm). The laser power is about 1 mW. The helicity of the laser is modulated between right (σ⁺) and left...
(σ−) circularly polarized light at 50 kHz by a photoelastic modulator (PEM), and the corresponding photocurrent intensities $I^{+}$ and $I^{-}$ are transformed into a voltage with a transimpedance amplifier (gain $10^7$) and detected with a lock-in amplifier. A magnetic field perpendicular to the photodiode is generated by a coil inserted inside a vibration-free closed-cycle cryostat where the sample is mounted.

III. RESULTS AND DISCUSSION

Prior to the growth, we first investigate the cleaning of the initial Ge(001) surface. Sun et al. [33] have suggested a method which combines one or more oxidation cycles in a diluted hydrogen peroxide solution followed by dissolution of the oxide in a HCl solution. Following this method, we obtain a rms surface roughness of about 1.3 nm, which is still a rather large value. Figure 1(a) shows an AFM image obtained after dipping a Ge(001) wafer in a 10% HCl solution for 5 min. The rms surface roughness is shown to decrease to about 0.21 nm, which is typical for a planar Ge(001) surface. This substrate is then immediately transferred into the MBE chamber. After 1-h annealing at 500 °C, the RHEED pattern [Fig. 1(b)] measured along the ⟨110⟩ direction exhibits, in addition to the (−1,0) and (0,1) streaks, the typical half-order (−1/2,0) and (0,1/2) streaks. This indicates that deoxidation has occurred leading to the well-known $(2 \times 1)$ reconstruction of the clean Ge(001) surface. We then deposit 2 nm MgO at RT onto the Ge(001)-(2 × 1) surface prior to annealing at 300 °C for 1 h. The RHEED patterns measured after annealing along the Ge ⟨100⟩ and ⟨110⟩ directions are shown in Figs. 1(c) and 1(d), respectively. One can recognize that the patterns consist of streaks indicating that MgO grows epitaxially onto the Ge(001)-(2 × 1) surface. We note that when the growth of MgO is directly performed at 225 °C, the streaks indicated with green arrows correspond to an epitaxial growth relationship of MgO[110]//Ge[100], i.e., with the MgO unit cell turned by about 45° with respect to the Ge unit cell [Fig. 1(e)]. The streaks indicated with red arrows correspond to an epitaxial growth relationship of MgO[100]//Ge[100], i.e., with cube-on-cube growth of the MgO unit cell on the Ge unit cell [Fig. 1(f)]. Since the streaks pointed at by green arrows are more intense than those pointed at by red arrows, we can thus conclude that MgO[110]//Ge[100] corresponds to the major growth direction. This is also the configuration which minimizes the misfit strain (5.2%) and thus the elastic energy. The minority growth direction MgO[100]//Ge[100] corresponds to the configuration which maximizes the misfit strain (25.6%) and thus the elastic energy. This is consistent with previous observations by Petti et al. [34]. In fact, the majority growth direction can be explained by the lattice-matching epitaxy (LME) approach, while the minority growth direction agrees with the prediction of the domain-matching epitaxy (DME) approach [35]. The different growth directions are also determined by the interfacial energies related to chemical interactions [34]. After a 2-nm MgO growth, the sample is transferred to the sputtering chamber without vacuum breaking, where MgO(0.5 nm)/Co-Fe-B(1.1 nm)/Ta(5 nm) is deposited at RT.

We perform STEM EELS combined analyses on the as-grown sample to study the interfacial structure and to get
information on the local chemistry. As shown in Fig. 2(a) recorded with STEM HAADF mode at low magnification, the interfaces between the layers appear very sharp and the layers have constant thickness and low roughness. Because heavy atoms diffuse more electrons than lighter ones, the contrast in STEM HAADF images is linked to the square of the mean atom number. On this micrograph, the Ge substrate is located on the bottom of the image. The MgO layer appears in dark whereas the metal layers appear in white due to Ta. A thin gray layer with contrast close to that of Ge is visible at the interface between MgO and Ta indicating the localization of the Co-Fe-B layer. The granular structure on the top of the multilayer is characteristic of a PtC protective layer deposited during the FIB processing (Pt grains in an amorphous C matrix). Between the metal layers and the PtC capping, a gray layer appears. It indicates that the Ta capping is oxidized at its surface on about 30% of its thickness. The HR-STEM BF images shown in Fig. 2(b) confirm the texture of the MgO layer observed by RHEED during the growth (Fig. 1) with MgO (001)/Ge (001). At the interface between the Ge substrate and the MgO layer [inset of Fig. 2(b)], a phase (2- or 3-atom planes in thickness, pointed at by red arrow) appears with a local lattice constant different from that of MgO or Ge and with a perfect epitaxy on Ge. The nature of this thin layer (less than 0.5-nm thick) will be identified using the spatially resolved EELS mapping. Figure 2(c) shows the element maps extracted from the quantitative analysis of an EELS spectrum image recorded in the area indicated by the red rectangle drawn on the STEM HAADF survey image [inset of Fig. 2(d)]. The Ge substrate is presented on the top of the images. This analysis clearly shows that the interface between Ge and MgO is oxygen-rich. Figure 2(d), constituted with the superposition of Ge L, Co L, Mg K, and Ta M signals, allows to precisely localize and estimate the thickness of the oxidized Ge layer. The result of the quantitative analysis in this area gives a mean atom ratio of 34% Ge and 64% O, close to GeO₂, without any other element. The thickness deduced from the overall contrast in the oxygen map and from the superposed elemental map is estimated to be about 0.45 nm. This thickness is in total accordance with the 2- or 3-atom planes seen at the interface on BF micrographs [inset of Fig. 2(b)]. This ultrathin GeO₂ layer between Ge and the MgO could be formed during or after the growth of the MgO layer since the RHEED patterns show only a clean Ge surface before MgO growth. Furthermore, the chemical maps allow to confirm the thickness of each deposited layer. MgO and Co-Fe-B layers appear to be 2.3- and 1.3-nm thick, respectively, from the EELS maps. Despite its thin thickness, the Co-Fe-B layer is continuous with a very homogeneous thickness and sharp interfaces on both sides. The ferromagnetic layer is found to have a mean ratio of 55% Fe and 45% Co, which is a bit richer in iron than is expected. It has to be noted that
even if boron is detected close to the Co-Fe-B/Ta interface, the signal is too weak for quantitative analysis with the STEM and spectrometer parameters chosen for this EELS mapping. Nevertheless, in our previous work on the EELS mapping of a Ta-capped Co-Fe-B/MgO spin injector deposited on a spin LED, boron diffusion in the Ta layer was detected due to Co-Fe-B crystallization after annealing [36]. As observed from the HAADF images, the Ta capping layer appears oxidized on the top of the surface for 2–3 nm. The atom ratio between Ta and O of 30:70 is very close to that of the stable Ta$_2$O$_5$ in the oxidized part. This Ta$_2$O$_5$ layer can effectively prevent the penetration of H$_2$O and oxygen, allowing long aging and high stability of the ultra-thin device.

A post-growth RTA annealing treatment is critical to initialize the crystallization of the Co-Fe-B electrode [37,38] and to establish the perpendicular magnetic anisotropy [14,39]. After RTA annealing at 250 °C for 3 min, the magnetic properties of the Ta/Co-Fe-B/MgO/Ge(001) heterostructure are characterized by SQUID measured at different temperatures. Figure 3(a) shows the magnetization $M$-$H$ curve measured at 10 K with the magnetic field applied either parallel ($H_{IP}$, black solid line) or perpendicular ($H_{OOP}$, red solid line) to the layer structure. One can recognize that the easy magnetization axis is clearly out-of-plane. Moreover, the remnant magnetization reaches approximately 85% of the saturation magnetization. Our measurements thus demonstrate the existence of a PMA for the ultrathin Co-Fe-B/MgO spin detector. It is noteworthy that the PMA can still be observed when the magnetization curves are measured at RT [Fig. 3(b)]. The remnant magnetization still reaches about 73% of the saturation magnetization and the coercive field is about 28 Oe. Figure 3(c) displays the evolution of the coercive field as a function of the temperature. The coercive field clearly decreases as the temperature increases. Our experimental results can be well fitted by a decreasing single exponential function in good agreement with previous results from the literature [40,41]. Finally, we further extract the effective anisotropy constant ($K_{eff}$) by calculating the difference in area between the magnetization loops measured when the magnetic field is applied perpendicular and parallel to the layers. The results are displayed in Fig. 3(d). Similar to the coercive field, the effective anisotropy constant decreases as the temperature increases. Our results are in good agreement with previous measurements by Yamanouchi et al. [42] on Co-Fe-B/MgO films deposited on thermally oxidized Si(001) substrates by rf magnetron sputtering.

The annealed film is then processed to fabricate the device. Figure 4(a) shows a cross-sectional view of the Ge-based spin photodiode. First, we characterize the Schottky barrier height (SBH) at the Co-Fe-B/MgO/Ge contact. Figure 4(b) shows a typical current-voltage characteristic measured from 180 to 300 K without illumination of light, indicating a rectifying Schottky behavior. In this temperature range, the thermionic emission transport mechanism through the Schottky barrier can be mainly considered,
which can be expressed as [43]

\[ I = A^* A T^2 \left[ \exp \left( \frac{qV}{nkBT} \right) - 1 \right] \exp \left( -\frac{q\phi_B}{k_BT} \right), \]  

where \( A \) is the contact area, \( A^* \) is the Richardson constant, \( q \) is the carrier charge, and \( n \) is the ideality factor. Since we want to extract the value of SBH for an electron to cross the tunneling barrier, we focus on the part of the negative bias with an inverse condition. When \( |V| > 3k_BT/q \), the Eq. (1) can be simplified as

\[ I = -A^* A T^2 \exp \left( -\frac{q\phi_B}{k_BT} \right). \]  

The SBH can be fitted from the slope of the Arrhenius plot \([\ln(I/T^2) vs 1000/T]\) and we obtain 0.23 eV. This value lies between the value obtained by Jeon et al. [43] where the Schottky barrier height was found to be about 140 meV for CoFe/MgO(2 nm)/n-Ge (\( n \sim 5 \times 10^{13} \text{ cm}^{-3} \)) for a MgO thickness of 2 nm, and the one obtained by Zhou et al. [44] of about 360 meV for Fe/MgO/n-Ge (\( n \sim 5 \times 10^{13} \text{ cm}^{-3} \)). The Schottky barrier height is dependent on the MgO/Ge interface and thus depends on the growth process. Figure 4(c) shows the schematic energy diagram of the Co-Fe-B/MgO/Ge contact. Figure 5(c) shows the photocurrent as a function of the bias obtained with an excitation wavelength of 980 nm at RT. It is interesting that the photocurrent falls to zero with \( V_{\text{bias}} = 0.2 \text{ V} \), indicating the flat band condition in Ge at this bias voltage. Therefore, we can estimate the built-in band bending \( V_{\text{bb}} \) in Ge to be about 0.2 eV, as indicated in Fig. 4(c). We also measure the photocurrent as a function of the laser power for different applied bias voltages \([V_{\text{bias}} = -1 \text{ V}, 0 \text{ V}, \text{and} +1 \text{ V}, \text{Fig. 4(d)}]\) and for a laser wavelength of 980 nm. The photocurrent exhibits a linear evolution with the laser power for all voltages considered here.

Figure 5(a) shows the evolution of the photocurrent helicity asymmetry, usually defined as \( \Delta I/I = (I^{\sigma^+} - I^{\sigma^-})/[(I^{\sigma^+} + I^{\sigma^-})/2] \), as a function of the applied magnetic field. \( \Delta I/I \) is measured with a laser wavelength \( \lambda \) of 980 nm under \( V_{\text{bias}} = -1 \text{ V} \) and \( T = 300 \text{ K} \). It is obvious that \( \Delta I/I \) increases with the increase of the magnetic field. For \( \mu_0H = 43 \text{ Oe} \), \( \Delta I/I \) reaches about 0.23%. As the magnetic field is swept from positive to negative values, \( \Delta I/I \) changes its signs. Interestingly, at a zero applied magnetic field, the photocurrent helicity asymmetry is not equal to zero and seems to depend on the increasing or decreasing character of the sweep of the magnetic field. We have confirmed this point by performing a sweep in the magnetic field with smaller steps around \( \mu_0H = 0 \) as shown in the enlarged view [Fig. 5(b)]. A helicity-dependent asymmetry of the photocurrent is thus evidenced without the need for any external magnetic field, contrary to previous works.
[28, 45]. However, the dependence of $\Delta I/I$ as a function of $\mu_0 H$ does not follow the hysteresis cycle of the Co-Fe-B injector measured by SQUID [Fig. 3(b)]. Since the spin-filtering effect ($\Delta I/I$) of the spin injector could be sensitive to the quality of the Co-Fe-B/MgO interface such as that in a spin-LED system [9], the magnetic field dependence of $\Delta I/I$ can reveal that the Co-Fe-B magnetization can be partially in-plane at the Co-Fe-B/MgO interface, which is very different from the PMA properties of the whole Co-Fe-B layer measured by SQUID [36, 46].

Now we focus on the measurement of the photocurrent helicity asymmetry at zero field ($\mu_0 H = 0$). Figure 5(c) shows $|\Delta I/I|$ measured as a function of the applied bias for two different excitation wavelengths (980 and 1310 nm) at RT without any applied magnetic field. The clear variation of $|\Delta I/I|$ as a function of the applied bias is a strong indication that the observed helicity-dependent asymmetry cannot be attributed to the MCD effect [21]. The variation mainly occurs for negative applied biases suggesting that the spin filtering of holes occurs. A similar observation was also reported by Rinaldi et al. [28, 45] on a device based on an electrode without PMA. Note that for excitation wavelengths $\lambda = 980$ nm and $\lambda = 1310$ nm, electrons and holes do not follow the same dynamics: electrons are photo-generated in the $\Gamma$ valley and are then very quickly scattered toward the $L$ valley (approximately 200 fs [47]). On the contrary, the holes remain in the $\Gamma$ valley where they have been photo-generated. Calculations based on density functional theory (DFT) indicate that the asymmetry (between spin up and down carriers) of the tunnel transmission coefficient through the MgO barrier is close to 100% in the $\Gamma$ valley whereas it is only 35% in the $L$ valley [28]. Thus, holes in the $\Gamma$ valley will experience a very efficient spin filtering. However, the hole spin relaxation time $\tau_s$ is very short, about 100 fs at RT [48]. On the other hand, despite a larger spin relaxation time expected for electrons (0.1–1 ns at RT [49]), the lower $|\Delta I/I|$ could be due to a weaker spin asymmetry of the tunnel transmission coefficient through the MgO barrier in the $L$ valley [28].

In order to estimate the maximum $|\Delta I/I|$ that we could reach, an analytic model has been developed (see Appendix) showing that $|\Delta I/I|_{\text{max}}$ scales with $P_S(1/\lambda_{opt} + 1/\lambda_{L})\lambda_S$ for $\lambda_S \ll \lambda_{opt}$ or $\lambda_R$, where $P_S$ is the photon-generated carrier spin polarization, $\lambda_S$ is the spin diffusion length, $\lambda_{opt}$ is the light absorption length, and $\lambda_R$ is the carrier recombination length. Taking into account a diffusion coefficient $D$ for holes of about 0.0049 m$^2$ s$^{-1}$ [50] leads
to a hole spin diffusion length $\lambda_\text{S} = \sqrt{D/\tau}$ of about 22 nm. Considering $\lambda_{\text{opt}} \approx 400$ nm at a wavelength of 980 nm [45], an effective lifetime $\tau_e = \lambda_\text{S}^2/D$ of about 10 $\mu$s [31], and a photo-generated hole spin polarization $P_\text{S}$ of about 15% at 980 nm [52], one can expect a maximum of $|\Delta I/I|$ to be about 0.8% at RT. Therefore, the short hole spin relaxation time is a strong limitation that explains the weakness of the detected signal.

Let us now compare the evolution of $|\Delta I/I|$ as a function of the applied bias when the excitation wavelength is changed from 980 to 1310 nm: $|\Delta I/I|$ increases from about 0.06% to about 0.11% at $V_{\text{bias}} = -1$ V. This may be partially due to an increased degree of optical spin orientation $P_\text{S}$ at 1310 nm as previously described by Rinaldi et al. [45] following the $k_p$ calculation by Rioux and Sipe [52] (at this particular wavelength, a polarization of both electrons and holes of about 45% has indeed been predicted, instead of 15% at 980 nm). Moreover, longer spin relaxation times for holes photo-generated at a lower energy are also expected to result in the lower $|\Delta I/I|$ values.

Finally, the temperature dependence of the helicity dependent photocurrent measured for an excitation wavelength of 980 nm is shown in Fig. 5(d). When the temperature decreases from 300 to 9 K, $|\Delta I/I|$ increases from about 0.06% to about 0.8%, i.e., by a factor of approximately 13. This could be linked to the increase of the carrier spin relaxation time (governed by carrier-phonon scattering) at low temperature that was reported for holes between 300 K (approximately 100 fs) [48] and 8 K (approximately 100 ps) [53], and for electrons between 300 K (approximately 1 ns) [54] and 4 K (approximately 100 ns) [25].

Note that the use of an ultrathin Co-Fe-B layer ensures low light absorption in the metallic spin detector layer which is favorable for the realization of a photodetector. We can make a simple estimation of the light absorption with the formula $P(t) = P_0 \exp(-\alpha t)$, where $P_0$ is the incident intensity and $P(t)$ is the intensity transmitted through a layer of material with thickness $t$. The attenuation coefficient is $\alpha$. For a wavelength of 980 nm, the $\alpha$ of Fe is about 4.85 $\times$ 10^{-4} cm^{-1} [55]. This leads the transmission of our 1.1-nm-thick magnetic electrode to be about 95%. However, it should be noted that for the 40-nm-thick Fe/Tb layer as employed previously in Ref. [21], the transmission is much more attenuated, reaching only about 14%.

**IV. CONCLUSIONS**

To summarize, we investigate the growth of an ultrathin Co-Fe-B/MgO spin detector on Ge(001) substrates by using a combination of both MBE and sputtering methods. The epitaxial growth of MgO on Ge is observed with two different orientations, i.e., MgO[110]/Ge[100] and MgO[100]/Ge[100] corresponding to the major growth direction and MgO[100]/Ge[100] corresponding to the minor growth direction. The ultrathin Co-Fe-B/MgO spin detector is characterized by a strong perpendicular magnetic anisotropy in the range 10–300 K. The perpendicularly magnetized Co-Fe-B/MgO interface appears to be deteriorated compared to the magnetic properties of the Co-Fe-B layer itself. Our findings may pave the way for the development of a spin photocurrent detector on Ge(001) substrates for future optical transport of spin information.

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**APPENDIX I. CALCULATION OF THE MAXIMUM OF PHOTOCURRENT HELICITY ASYMMETRY**

We develop a simple analytic model to estimate the maximum of photocurrent helicity asymmetry in our measurement conditions. We have to discriminate between the hole and electron carrier photocurrent generated by optical pumping under the negative bias where the spin photocurrent is maximum. Under these experimental conditions, the external electric field adds up to the built-in Schottky electric field having the effect to drive the electrons out of the tunnel barrier interface region toward the “bulk” Ge and to drive the hole in the ferromagnetic contact through the tunnel barrier. We then mainly observe a hole photocurrent. We demonstrate that the electric field has a dominant effect on the electron photocurrent and mostly no effect on the hole photocurrent. We then determine the equations of holes’ transport under pumping and the equations giving the hole photocurrent. Our simplified equations will
slightly depart from the previous coupled electron-hole equations derived by Isella et al. [56] by the consideration of specific boundary conditions for a spin-polarized photocurrent due to the presence of a contact resistance played by the tunnel barrier.

1. General transport equations for carriers involving the electric field effect

The general transport equations for pumped carriers’ density \( n(z) \) under a static electric field, \( E(z) \), are

\[
\frac{J(z)}{e} = -D \nabla n(z) + n(z) \epsilon \mu E(z) \quad \text{and} \quad (A1)
\]

\[
\frac{dn(z)}{dt} = -\nabla J(z) - \frac{n(z)}{\tau_R} + G(z), \quad (A2)
\]

where \( J(z) \) is the photocurrent, \( \mu \) is the carrier mobility, \( D = kT\tau_p/e \) is the diffusion constant (\( \tau_p \) is the characteristic collision time), and \( \tau_R \) represents a certain relaxation time (spin-flip time in the present case). \( G(z) = G_0 e^{-z/\lambda} \) is the carrier generation per unit time by optical pumping rate which attenuates with an exponential absorption coefficient (inverse of the absorption length \( \lambda_{\text{opt}} \)). The first equation expresses the dual contributions of the respective diffusive term, \(-D \nabla n(z)\), and the drift term, \( n(z) \epsilon \mu E(z) \), on the current. The second equation expresses the charge conservation. Depending on the strength of the electric field with respect to a certain critical value, \( E_c \), either the drift or diffusion contribution will be dominant. The development of the coupled equations gives a value of \( E_c \) equaling \( E_c = D/\mu \lambda_R \) [57] where \( \lambda_R (= \sqrt{D\tau_R}) \) is the corresponding relaxation length (e.g., the spin diffusion length in the present case).

The examination of the present condition \( E \ll D/\mu \lambda_R \) or \( E \gg D/\mu \lambda_R \) with \( E \equiv e\Phi/L_D + E_n \), where \( \Phi \) is the Schottky barrier height, \( L_D \) is its depletion length (of the order of hundreds of 100 nm at low doping case), and \( E_n \) is the external electric field applied, leads to the conclusion that the electric field has almost no effect on the hole photocurrent (a very short spin-diffusion length of 22 nm leading to a strong diffusive current). On the contrary, the \( E \) field is predominant for the electron photocurrent due to its expected long spin-diffusion length at low doping of the order of 1 \( \mu \)m.

2. Transport equations for holes involving no electric-field effect

We consider now the detailed hole transport equation of density \( p(z) \) free of the presence of an electric field. One notes that \( p(z) \) is the profile of the optically pumped carrier density, thus the diffusive current \( J \) generated in Ge at zero bias can be described by the two equations concerning the spatial distribution and dynamic equilibrium according to

\[
\frac{J(z)}{e} = -D \nabla p(z) \quad \text{and} \quad (A3)
\]

\[
\frac{dp(z)}{dt} = -\nabla J(z) - \frac{p(z)}{\tau_R} + G(z). \quad (A4)
\]

For spin-polarized carriers, \( \tau_R \) is the effective carrier recombination time involving the spin-flip term \( \tau_s (1/\tau_R = 1/\tau_{R0} + 1/\tau_s) \) with \( \tau_{R0} \) being the intrinsic unpolarized hole recombination time.

When \( dp(z)/dt = 0 \) in the steady-state regime, we get

\[
\nabla J(z) = -\frac{p(z)}{\tau_R} + G(z). \quad (A5)
\]

By injecting equation (A3) into (A5) we obtain

\[
D \frac{\partial^2 p(z)}{\partial z^2} = \frac{p(z)}{\tau_R} - G(z). \quad (A6)
\]

One notes that \( D\tau_R = \lambda_R^2 \), where \( \lambda_R \) is the carrier recombination length, and in general \( \lambda_R \neq \lambda_{\text{opt}} \).

By resolving the differential equation (A6) we get

\[
p(z) = \frac{-G_0/D}{1/\lambda_{\text{opt}}^2 - 1/\lambda_R^2} e^{-z/\lambda_{\text{opt}}} + \Delta_p e^{-z/\lambda_R} \quad \text{(A7)}
\]

where \( \Delta_p \) is a constant which can be determined by the boundary condition.

At the interface ferromagnet (FM)/semiconductor (SC) (\( z = 0 \)), we get the current \( J_s \) from Eq. (A7):

\[
J_{s|z=0} = -D \nabla p(z = 0) = -\frac{G_0/\lambda_{\text{opt}}}{1/\lambda_{\text{opt}}^2 - 1/\lambda_R^2} + \frac{\Delta_p D}{\lambda_R} \quad \text{(A8)}
\]

In fact, \( J_s \) can be also expressed as

\[
J_{s|z=0} = -V_s^2 p(z = 0) = -V_s^2 \left( \frac{-G_0/D}{1/\lambda_{\text{opt}}^2 - 1/\lambda_R^2} + \Delta_p \right) \quad \text{(A9)}
\]

where \( V_s^2 \) is an effective “surface recombination velocity” (related to the tunneling transmission of the barrier).
Thus, the maximum of the photocurrent helicity asymmetry related to the spin-up and spin-down carriers, respectively.

\[ \Delta p = \frac{G_0}{1/\lambda_{opt} - 1/\lambda_R} \left( \frac{1/\lambda_{opt} + V_s^T/D}{D/\lambda_R + V_s^T} \right) \]  
(A10)

The measured photocurrent \( I_{ph} \) can be expressed as follows:

\[ I_{ph} = -J_\lambda = V_s^T p(z = 0) = V_s^T \left( \frac{-(G_0/D)}{1/\lambda_{opt} - 1/\lambda_R} + \Delta p \right) \]  
(A11)

By injecting equation (A10) into (A11), we can get

\[ I_{ph} = \frac{V_s^T}{D} \left[ \frac{-G_0}{1/\lambda_{opt} - 1/\lambda_R} + \frac{G_0}{1/\lambda_{opt} - 1/\lambda_R} \left( \frac{V_s^T + D/\lambda_{opt}}{V_s^T + D/\lambda_R} \right) \right] \]
\[ = \frac{V_s^T G_0}{1/\lambda_{opt} + 1/\lambda_R} \left( \frac{1}{V_s^T + D/\lambda_R} \right) \]  
(A12)

For the spin-polarized photocurrent, one can replace \( G_0 \rightarrow P_S G_0 \) (\( P_S \) is the spin-polarization of carriers) and \( \lambda_R \rightarrow \lambda_S \) (\( \lambda_S \) is the spin diffusion length). The spin-polarized photocurrent \( I_{ph}^S \) can be expressed as

\[ I_{ph}^S = \frac{P_S V_s^T G_0}{1/\lambda_{opt} + 1/\lambda_S} \left( \frac{1}{V_s^T + D/\lambda_S} \right) \]  
(A13)

The spin-polarization of the photocurrent is determined by the ratio between \( I_{ph}^S \) and \( I_{ph} \), and can be expressed as

\[ p^{(ph)} = \frac{I_{ph}^S}{I_{ph}} = P_S \left( \frac{1/\lambda_{opt} + 1/\lambda_S}{1/\lambda_{opt} + 1/\lambda_R} \right) \frac{V_s^T + D/\lambda_S}{V_s^T + D/\lambda_R} \]  
(A14)

For the measured photocurrent helicity asymmetry in our paper, which can be further examined by the spin-dependent filtering of the FM spin detector as follows:

\[ \frac{\Delta I}{I} = p^{(ph)} \left( \frac{V_s^T + V_s^{T\dagger}}{V_s^T + V_s^{T\dagger}} \right) \]  
(A15)

where \( V_s^{T\dagger} \) and \( V_s^{T\dagger} \) are surface recombination velocities related to the spin-up and spin-down carriers, respectively. Thus, the maximum of the photocurrent helicity asymmetry can be assumed to be \( (\Delta I/I)_{\text{max}} = p^{(ph)} \) when \( (V_s^{T\dagger} - V_s^{T\dagger})/(V_s^{T\dagger} + V_s^{T\dagger}) = 1 \).

Generally, \( \lambda_S \ll \lambda_R \) or \( \lambda_{opt} \), so Eq. (A15) can be simplified as

\[ \left( \frac{\Delta I}{I} \right)_{\text{max}} = P_S \left( \frac{1}{\lambda_{opt} + \frac{1}{\lambda_R}} \right) \frac{\lambda_S}{\lambda_S + \frac{D/\lambda_R}{V_s^T}} \]  
(A16)

(1) In the limit condition of zero surface recombination velocity \( (V_s^{T\dagger} = 0) \), most of the photogenerated carriers are blocked by the barrier and recombined in the interface localized states:

\[ \left( \frac{\Delta I}{I} \right)_{\text{max}} = P_S \left( \frac{1}{\lambda_{opt} + \frac{1}{\lambda_R}} \right) \frac{\lambda_S^2}{\lambda_R} \]  
(A17)

(2) In the limit condition of a large surface velocity (large transmission coefficient), which corresponds to our experimental conditions,

\[ \left( \frac{\Delta I}{I} \right)_{\text{max}} = P_S \left( \frac{1}{\lambda_{opt} + \frac{1}{\lambda_R}} \right) \lambda_S \]  
(A18)

3. Transport equations for electrons involving the electric field effect

The transport equations in the case of a dominant electric field (case of electrons) are

\[ \frac{J(z)}{e} = n(z) \mu E(z) \]  
(A19)

\[ \frac{dn(z)}{dt} = -\nabla \cdot J(z) - \frac{n(z)}{\tau_E} + G(z) = 0. \]  
(A20)

This leads to the resolution of the equation for \( n(z) \) of the form

\[ n(z) - n(z = 0) = \frac{G_0}{\mu E \tau_E} \left( e^{(z/\lambda_{opt})} - e^{-(z/\lambda_E)} \right) \]

with \( \lambda_E = (eE/m)\tau_p \tau_S \). The boundary condition at the interface with the tunnel barrier leads to \( n(z = 0) = 0 \) in that situation of an opposite current sign between electrons escaping toward the ferromagnetic contact and drift current toward the bulk Ge. The solution of the transport equation then is

\[ n(z) = \frac{G_0}{\mu E \tau_E} \left( e^{(z/\lambda_{opt})} - e^{-(z/\lambda_E)} \right). \]

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